

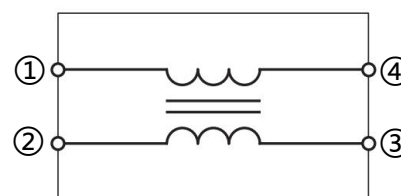
## Desicription

- ◆ The common mode filter is mainly used to reduce radiation and high frequency common mode noise.
- ◆ Reduce asymmetric interference on data lines and other interfaces.
- ◆ Impedance characteristics match the impedance of most differential interface Settings, controlling unnecessary reflection formation
- ◆ Low leakage, no effect on differential mode current



## Features

- ◆ Size:2.0mm\*1.2mm\*1.2mm
- ◆ Halogen free ,Lead free ,Reach and RoHs



**Circuit Diagram**

## Application

- ◆ Cellular phones
- ◆ Portable devices
- ◆ Digital cameras
- ◆ Player
- ◆ Smart home
- ◆ Robot

PIN NUMBER	DESCRIPTION
① ~ ④	DATE LINE
② ~ ③	DATE LINE

## Order information

Model	Package	shipping
CMF2012WD900MDT	2012	2000/Tape&Reel

## Part Numbering

<b>CMF</b>	<b>2012</b>	<b>W</b>	<b>D</b>	<b>900</b>	<b>M</b>	<b>D</b>	<b>T</b>
A	B	C	D	E	F	G	H

A:ASIM common mode filter

B:Dimension

C:Wire wound

D:Shielding type

E:Impedance 900=90 Ω

F:Tolerance M±25%

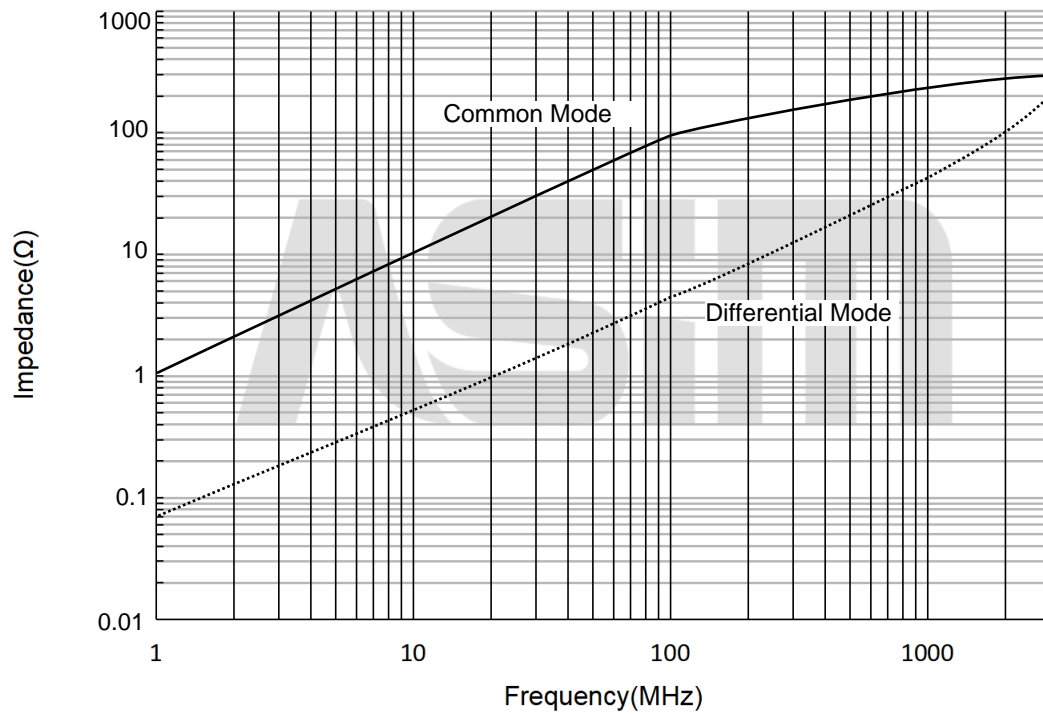
G:Internal series

H:Tape

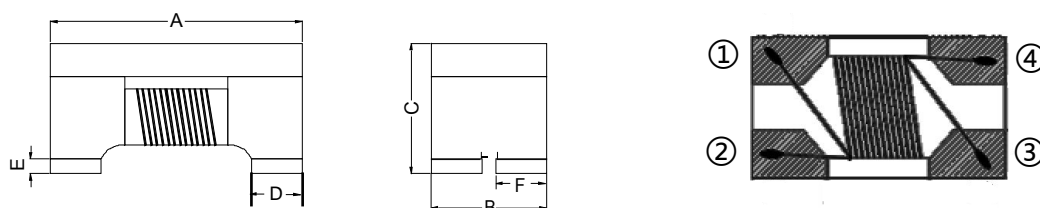
## Specification

Part number	Common mode impedance(Ω) @100MHz	Rated Current (mA)	DC Resistance (Ω) max
CMF2012WD900MDT	90 ±25%	330	0.35
	Rated volt (Vdc)	Withstand volt (Vdc)	IR (Ω) min
	50	125	10M
	Operation junction temperature	Lead temperature	Storage temperature
	-40℃~+105℃	260℃	-10℃~40℃

## Performance Curves

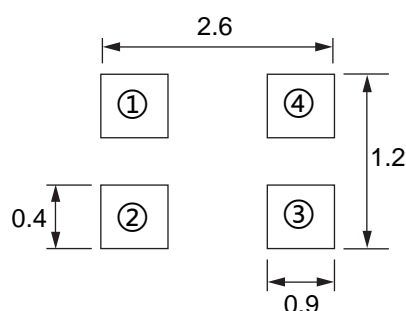


## Dimension



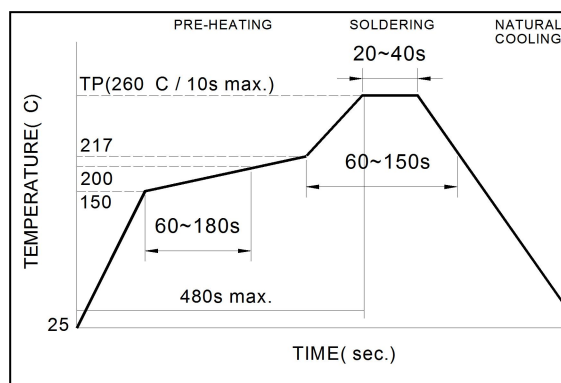
A(mm)	B(mm)	C(mm)	D(mm)	F(mm)	E(mm)
2.0±0.2	1.2±0.2	1.2±0.2	0.55±0.1	0.46±0.1	0.15±0.1

## Recommended Land Pattern (mm)



## Recommended Reflow Profile

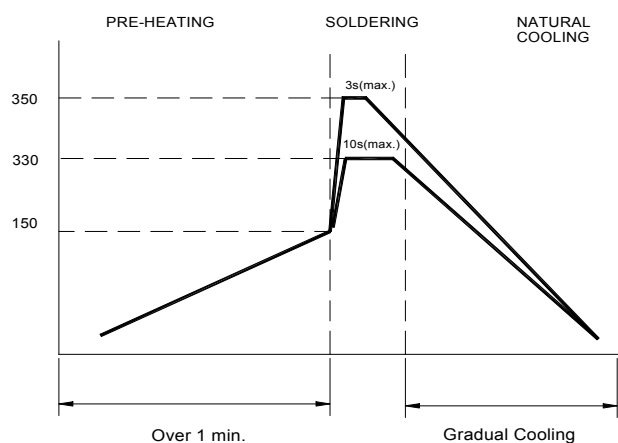
**Figure 1.**  
**Re-flow Soldering**  
**(Lead Free)**



Note:

- Preheat circuit and products to 150°C
- 260°C tip temperature (max)
- Reflow times: no more than 2 times
- Solder paste thickness: the best 0.08mm is ,but max is 0.1mm

**Figure 2.**  
**Hand Soldering**



Note:

- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 3 sec.